Nch 45V 7A Power MOSFET

V_{DSS}	45V
R _{DS(on)} (Max.)	25mΩ
I _D	±7.0A
P_D	2.0W

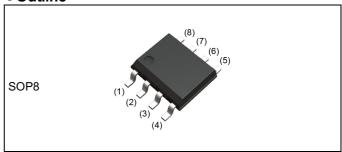
Features

- 1) Low on-resistance
- 2) Small Surface Mount Package (SOP8)
- 3) Pb-free lead plating; RoHS compliant
- 4) AEC-Q101 Qualified

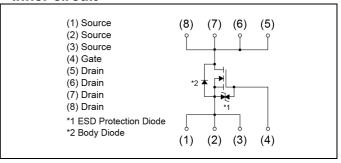
Application

Switching

Outline



●Inner circuit



Packaging specifications

	Packing	Embossed Tape
	Reel size (mm)	330
Туре	Tape width (mm)	12
-	Basic ordering unit (pcs)	2500
	Taping code	ТВ
	Marking	RSS070N05

● **Absolute maximum ratings** (T_a = 25°C ,unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain - Source voltage	V _{DSS}	45	V
Continuous drain current	I _D	±7.0	Α
Pulsed drain current	I _{DP} *1	±28	Α
Gate - Source voltage	V _{GSS}	±20	V
Davier discinction	P _D *2	2.0	W
Power dissipation	P _D *3	1.4	W
Junction temperature	T _j	150	°C
Operating junction and storage temperature range	T _{stg}	-55 to +150	°C

●Thermal resistance

Dorameter	Cumb of	Values			l leit
Parameter	Symbol	Min.	Тур.	Max.	Unit
Thermal registeres innetion, embient	R _{thJA} *2	-	1	62.5	°C/W
Thermal resistance, junction - ambient	R _{thJA} *3	-	1	89.2	°C/W

● Electrical characteristics (T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit	
Farameter Sym		Conditions	Min.	Тур.	Max.	Ullit	
Drain - Source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 1mA	45	-	-	V	
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_{j}}$	I _D = 1mA referenced to 25°C	-	46.8	-	mV/°C	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 45V, V _{GS} = 0V	-	1	1	μA	
Gate - Source leakage current I _{GSS}		$V_{GS} = \pm 20V, V_{DS} = 0V$	-	1	±10	μA	
Gate threshold voltage V _{GS(th}		$V_{DS} = 10V, I_{D} = 1mA$	1.0	-	2.5	V	
Gate threshold voltage temperature coefficient	$\frac{\Delta V_{GS(th)}}{\Delta T_{j}}$	I _D = 1mA referenced to 25°C	-	-3.9	-	mV/°C	
		V _{GS} = 10V, I _D = 7A	-	18	25		
Static drain - source on - state resistance	R _{DS(on)} *4	$V_{GS} = 4.5V, I_D = 7A$	-	23	32	mΩ	
		$V_{GS} = 4.0V, I_D = 7A$	-	25	35		
Gate resistance	R_G	R _G f = 1MHz, open drain		3.2	1	Ω	
Forward Transfer Admittance	Forward Transfer $ Y_{fo} ^{*4}$ $ V_{DC} = 10 \text{V} D = 7 \text{A}$		6.0	-	-	S	

^{*1} Pw \leq 10 μ s, Duty cycle \leq 1%

^{*2} Mounted on a ceramic board (30×30×0.8mm)

^{*3} Mounted on a FR4 (25×25×0.8mm)

^{*4} Pulsed

●Electrical characteristics (T_a = 25°C)

Darameter	Cumahad	Conditions	Values			Unit	
Parameter	Symbol Conditions —		Min.	Тур.	Max.	Urlit	
Input capacitance	C _{iss}	V _{GS} = 0V	-	1000	-	_	
Output capacitance	C _{oss}	V _{DS} = 10V	-	230	-	pF	
Reverse transfer capacitance	C_{rss}	f = 1MHz	-	125	-		
Turn - on delay time	t _{d(on)} *4	V _{DD} ≈ 25V,V _{GS} = 10V	-	16	-		
Rise time	t _r *4	I _D = 3.5A	-	27	-	no	
Turn - off delay time	t _{d(off)} *4	$R_L \simeq 7.1\Omega$	-	57	-	ns	
Fall time	t _f *4	$R_G = 10\Omega$	-	21	-		

• Gate charge characteristics $(T_a = 25^{\circ}C)$

	\ u	,				
Parameter	Symbol	Conditions	Values			Unit
raiametei	Symbol	Conditions	Min.	Тур.	Max.	Offic
Total gate charge	Qg*4	V _{DD} ≃ 25V.	-	12.0	16.8	
Gate - Source charge	Q _{gs} *4	$V_{DD} \approx 25V$, $I_D = 7A$,	-	3.0	-	nC
Gate - Drain charge	Q _{gd} *4	$V_{GS} = 5V$	-	4.6	-	

●Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Darameter	Symbol	Conditions	Values			Linit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Continuous forward current	I _S	T - 25°C	-	-	1.6	Α	
Pulse forward current	I _{SP} *1	T _a = 25°C	-	-	28	Α	
Forward voltage	V _{SD} *4	V _{GS} = 0V, I _S = 1.6A	-	-	1.2	V	

Electrical characteristic curves

Fig.1 Power Dissipation Derating Curve

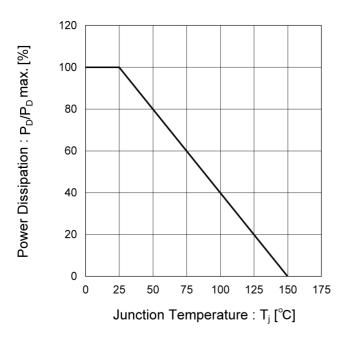
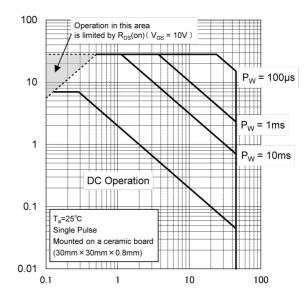


Fig.2 Maximum Safe Operating Area



Drain Current : I_D [A]

Drain - Source Voltage: V_{DS}[V]

Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

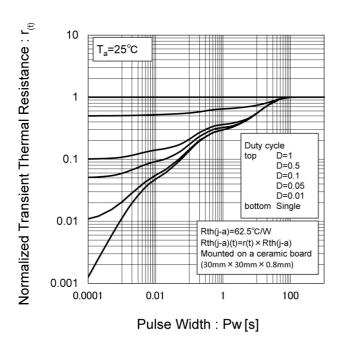
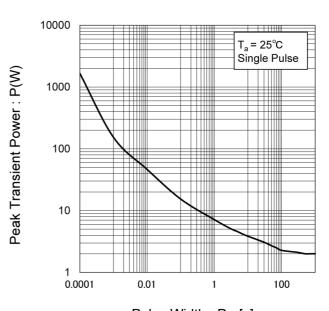


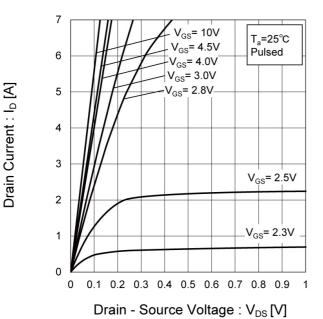
Fig.4 Single Pulse Maximum Power dissipation



Pulse Width : Pw [s]

Electrical characteristic curves

Fig.5 Typical Output Characteristics(I)



Drain Current : I_D [A]

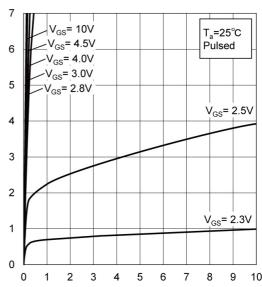
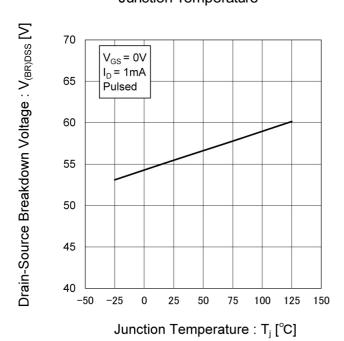


Fig.6 Typical Output Characteristics(II)

Drain - Source Voltage : V_{DS} [V]

Fig.7 Breakdown Voltage vs. **Junction Temperature**



• Electrical characteristic curves

Fig.8 Typical Transfer Characteristics

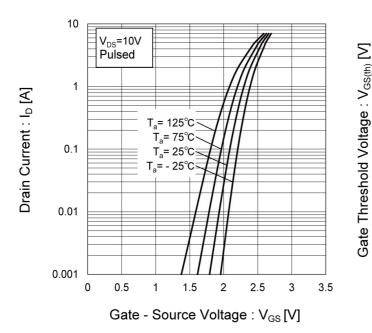


Fig.9 Gate Threshold Voltage vs.
Junction Temperature

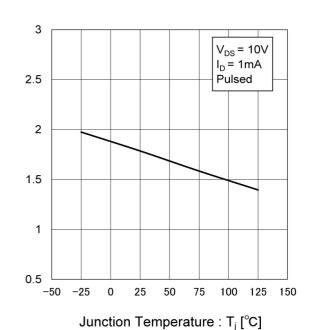
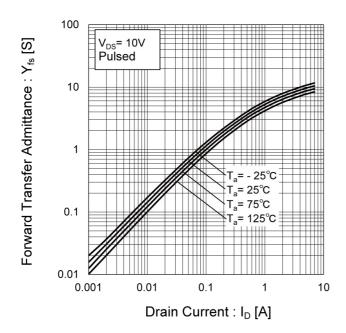


Fig.10 Forward Transfer Admittance vs.
Drain Current



RSS070N05FRA Datasheet

• Electrical characteristic curves

Fig.11 Drain Current Derating Curve

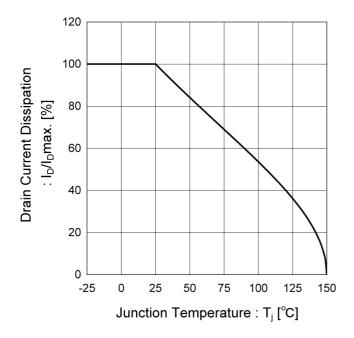


Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage

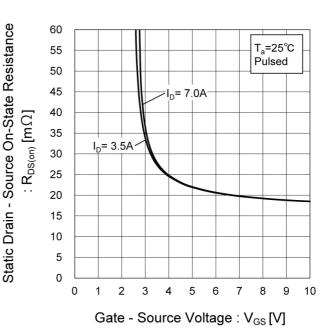
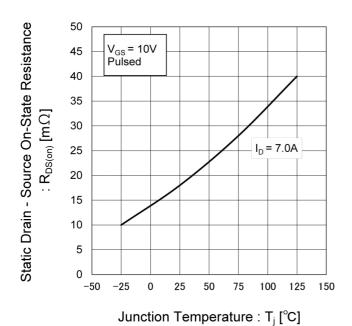


Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature



• Electrical characteristic curves

Fig.14 Static Drain - Source On - State
Resistance vs. Drain Current (I)

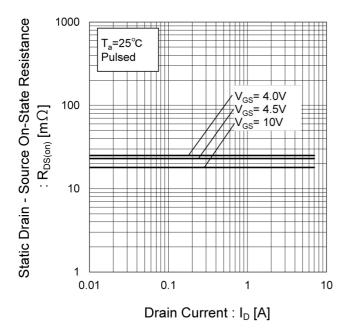


Fig.15 Static Drain - Source On - State Resistance vs. Drain Current (II)

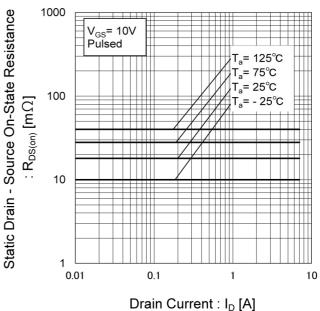


Fig.16 Static Drain - Source On - State Resistance vs. Drain Current (III)

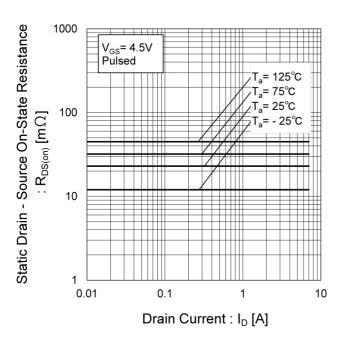
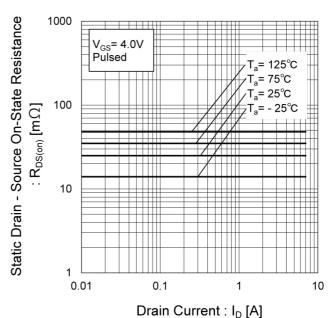


Fig.17 Static Drain - Source On - State Resistance vs. Drain Current (IV)



8/11

• Electrical characteristic curves

Fig.18 Typical Capacitance vs.

Drain - Source Voltage

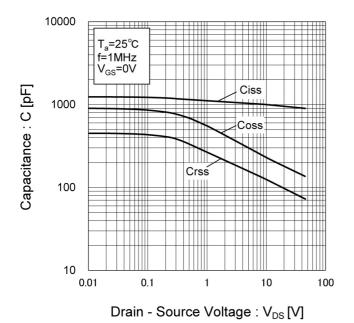


Fig.19 Switching Characteristics

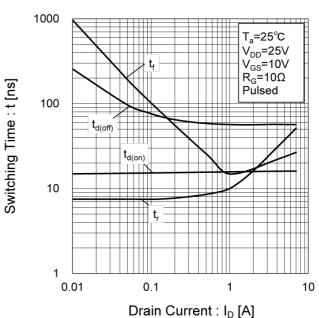


Fig.20 Dynamic Input Characteristics

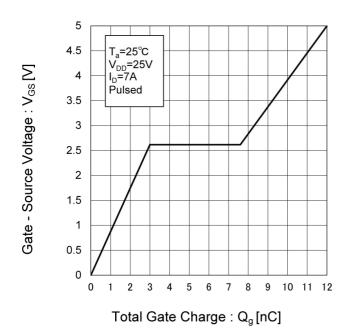
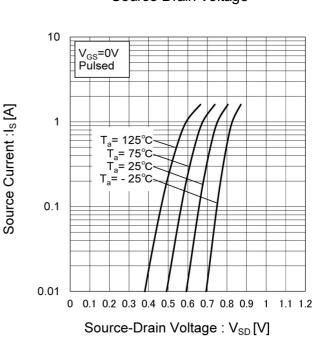


Fig.21 Source Current vs.

Source Drain Voltage



Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

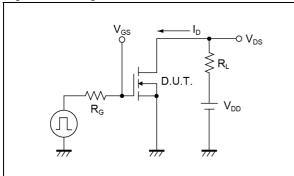


Fig.2-1 Gate Charge Measurement Circuit

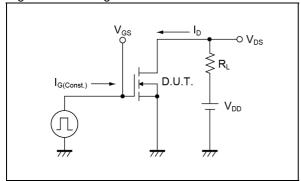


Fig.1-2 Switching Waveforms

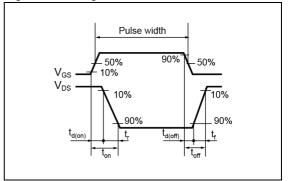
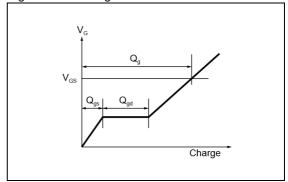
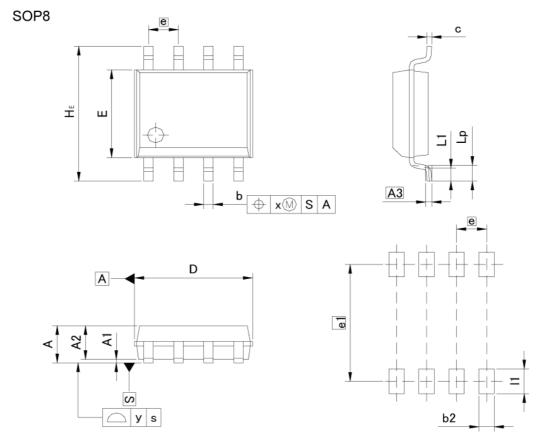


Fig.2-2 Gate Charge Waveform



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	-	1.75	_	0.069
A1	0.	15	0.0	006
A2	1.40	1.60	0.055	0.063
A3	0.25		0.0	10
b	0.30	0.50	0.012	0.020
С	0.10	0.30	0.004	0.012
D	4.80	5.20	0.189	0.205
E	3.75	4.05	0.148	0.159
е	1.	27	0.050	
HE	5.70	6.30	0.224	0.248
L1	0.40	0.60	0.016	0.024
Lp	0.65	0.85	0.026	0.033
х	0.15		0.0	006
у	0.10		0.0	004
	MILIMETERS		INC	HES
DIM	MINI	MAV	MINI	MAN

DIM	MILIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
b2	-	0.65	-	0.026	
e1	5.15		0.2	:03	
11		1.15	- 1	0.045	

Dimension in mm/inches



Notice

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JAPAN	USA	EU	CHINA
CLASSⅢ	OL ACOM	CLASS II b	ОГУООШ
CLASSIV	CLASSⅢ	CLASSⅢ	CLASSⅢ

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 - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - If Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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